

KSD1621

High Current Driver Applications

- Low Collector-Emitter Saturation Voltage
- Large Current Capacity and Wide SOA WWW.DZSC.COM
- · Fast Switching Speed
- Complement to KSB1121



SOT-89

1. Base 2. Collector 3. Emitter

NPN Epitaxial Silicon Transistor

Absolute Maximum Ratings Ta=25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V _{CBO}	Collector-Base Voltage	30	V
V _{CEO}	Collector-Emitter Voltage	25	V
V _{EBO}	Emitter-Base Voltage	6	V
Ic	Collector Current	2	А
P _C	Collector Power Dissipation	500	mW
P _C *	W.DZS	1.3	W
TJ	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55 ~ 150	°C

^{*} Mounted on Ceramic Board (250mm²x0.8mm)

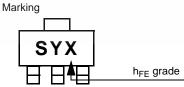
Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	I _C =10μA, I _E =0	30		_1 7	V
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C =1mA, I _B =0	25			V
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E =10μA, I _C =0	6			V
I _{CBO}	Collector Cut-off Current	V _{CB} =20V, I _E =0			100	nA
I _{EBO}	Emitter Cut-off Current	$V_{BE}=4V, I_{C}=0$			100	nA
h _{FE1}	DC Current Gain	V _{CE} =2V, I _C =0.1A	100		560	
h _{FE2}	1-1	V _{CE} =2V, I _C =1.5A	65			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C =1.5A, I _B =75mA		0.18	0.4	V
V _{BE} (sat)	Base-Emitter Saturation Voltage	I _C =1.5A, I _B =75mA		0.85	1.2	V
f _T	Current Gain Bandwidth product	V _{CE} =10V, I _C =50mA		150	-111	MHz
C _{ob}	Output Capacitance	V _{CB} =10V, I _E =0, f=1MHz		19	07	pF
t _{ON}	* Turn On Time	V _{CC} =12V, V _{BE} =5V		60		ns
t _{STG}	* Storage Time	I _{B1} = -I _{B2} =25mA		500		ns
t _F	* Fall Time	$I_C=0.5A$, $R_L=25\Omega$		25		ns

^{*} Pulse Width=20µs, Duty Cycle≤1%

h_{FE} Classification

Classification	R	S	Т	U
h _{FE}	100 ~ 200	140 ~ 280	200 ~ 400	280 ~ 560





Typical Characteristics

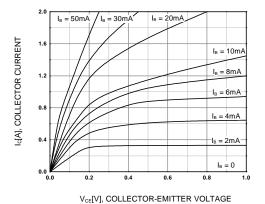


Figure 1. Static Characteristic

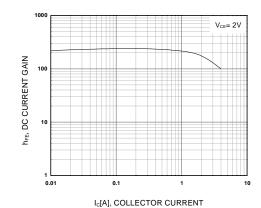


Figure 2. DC current Gain

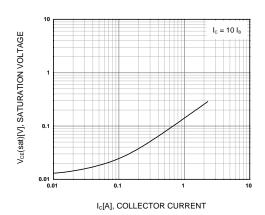


Figure 3. Collector-Emitter Saturation Voltage

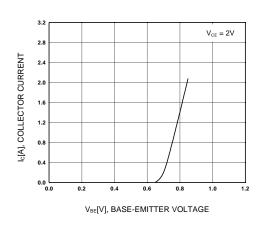


Figure 4. Base-Emitter On Voltage

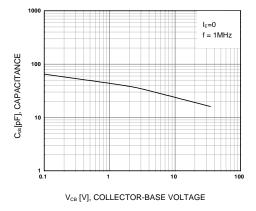


Figure 5. Collector Output Capacitance

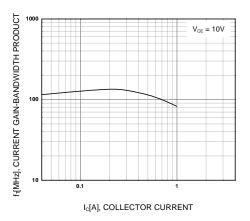


Figure 6. Current Gain Bandwidth Product

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Typical Characteristics (Continued)

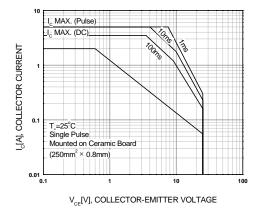


Figure 7. Safe Operating Area

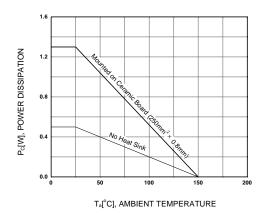
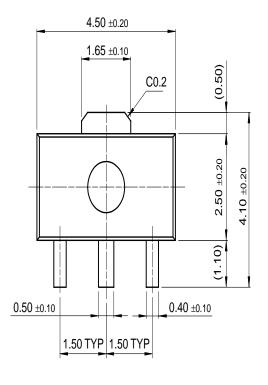
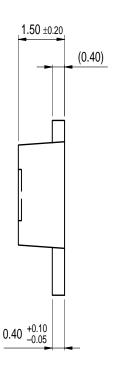


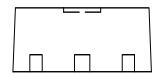
Figure 8. Power Derating

Package Dimensions

SOT-89







Dimensions in Millimeters

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CROSSVOLT™	FRFET™	MicroPak™	QFET™	SuperSOT™-8
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